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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

MIC5333

Micro-Power High Performance Dual 300mA ULDO™ with Dual POR

General Description

The MIC5333 is a tiny dual low quiescent current LDO ideal for applications that are power sensitive. The MIC5333 integrates two high performance, 300mA LDOs, and a POR generator for each LDO into a 2.5mm x 2.5mm Thin MLF® package, which occupies less PC board area than a single SOT-23 package.

The MIC5333 is designed to reject input noise and provide low output noise with fast transient response to respond to any load change quickly even though it is a low quiescent current part. This combination of PSRR, low noise and transient response along with low power consumption makes for a very high performance, yet general purpose product.

The MIC5333 is a µCap design, operating with very small ceramic output capacitors, which reduces required board space and component cost; and it is available in fixed output voltages in the tiny 10-pin 2.5mm x 2.5mm Thin MLF® leadless package.

Data sheets and support documentation can be found on Micrel's web site at: www.micrel.com.

Features

- 2.3V to 5.5V input voltage range
- 300mA output current per LDO
- Very low quiescent current: 25µA per LDO
- POR output with programmable delay for each LDO
- High PSRR – >65dB on each LDO
- Stable with 1µF ceramic output capacitors
- Tiny 10-pin 2.5mm x 2.5mm Thin MLF® package
- Ultra-low dropout voltage – 120mV @ 300mA
- Low output voltage noise – 50µVrms
- Thermal shutdown protection
- Current limit protection

Applications

- Camera phones
- Mobile phones
- PDAs
- GPS receivers
- Portable devices

Typical Application
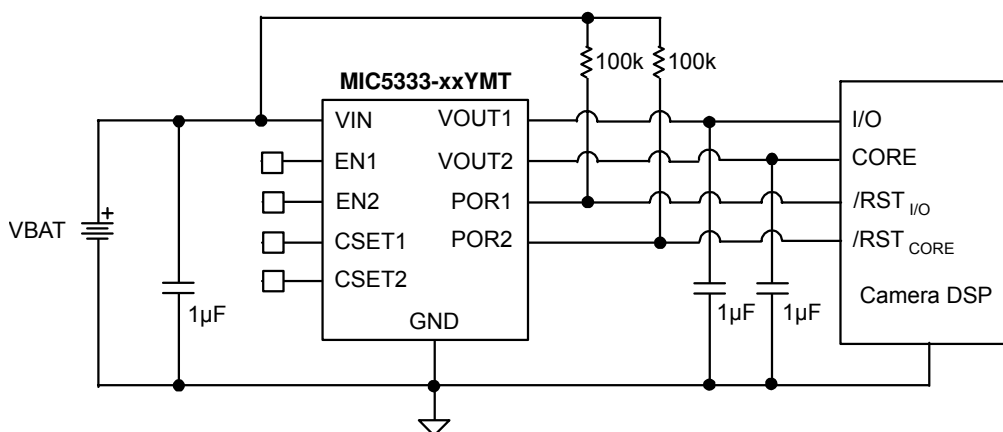
Camera DSP Power Supply Circuit

ULDO is a trademark of Micrel, Inc.
MLF and *Micro*LeadFrame are registered trademarks of Amkor Technology, Inc.

Ordering Information

Part Number	Manufacturing Part Number	Marking	Voltage	Junction Temperature Range	Package
MIC5333-2.5/1.2YMT	MIC5333-J4YMT	XJ4	2.5V/1.2V	–40° to +125°C	10-Pin 2.5 x 2.5 Thin MLF®
MIC5333-2.8/2.8YMT	MIC5333-MMYMT	XMM	2.8V/2.8V	–40° to +125°C	10-Pin 2.5 x 2.5 Thin MLF®
MIC5333-2.8/2.85YMT	MIC5333-MNYMT	XMN	2.8V/2.85V	–40° to +125°C	10-Pin 2.5 x 2.5 Thin MLF®
MIC5333-2.85/2.85YMT	MIC5333-NNYMT	XNN	2.85V/2.85V	–40° to +125°C	10-Pin 2.5 x 2.5 Thin MLF®
MIC5333-3.0/2.8YMT	MIC5333-PMYMT	XPM	3.0V/2.8V	–40° to +125°C	10-Pin 2.5 x 2.5 Thin MLF®
MIC5333-3.0/2.85YMT	MIC5333-PNYMT	XPN	3.0V/2.85V	–40° to +125°C	10-Pin 2.5 x 2.5 Thin MLF®
MIC5333-3.0/3.0YMT	MIC5333-PPYMT	XPP	3.0V/3.0V	–40° to +125°C	10-Pin 2.5 x 2.5 Thin MLF®

Note: Other voltage options available. Contact Micrel for details.

Pin Configuration
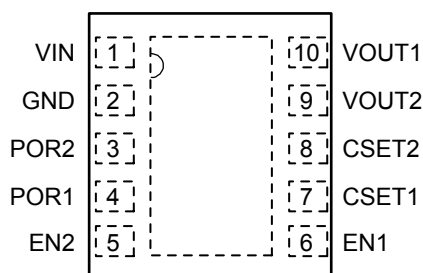
10-Pin 2.5mm x 2.5mm Thin MLF® (MT)
(Top View)

Pin Description

Pin Number	Pin Name	Pin Function
1	VIN	Supply Input.
2	GND	Ground.
3	POR2	Power-On Reset Output (Regulator 2): Open-drain output. Active low indicates an output under-voltage condition on regulator 2 when the device is enabled.
4	POR1	Power-On Reset Output (Regulator 1): Open-drain output. Active low indicates an output under-voltage condition on regulator 1 when the device is enabled.
5	EN2	Enable Input (Regulator 2): Active High Input. Logic High = On; Logic Low = Off. Do not leave floating.
6	EN1	Enable Input (Regulator 1): Active High Input. Logic High = On; Logic Low = Off. Do not leave floating.
7	CSET1	Delay Set Input (Regulator 1): Connect external capacitor to GND to set the internal delay for the POR1 output. When left open, there is no delay. This pin cannot be grounded.
8	CSET2	Delay Set Input (Regulator 2): Connect external capacitor to GND to set the internal delay for the POR2 output. When left open, there is no delay. This pin cannot be grounded.
9	VOUT2	Regulator Output – LDO2.
10	VOUT1	Regulator Output – LDO1.

Absolute Maximum Ratings[1]

Supply Voltage (V_{IN})............................ 0V to +6V
Enable Input Voltage (V_{EN1}, V_{EN2}) ....0V to V_{IN}
POR Voltage (V_{POR1}, V_{POR2}) .... 0V to +6V
Power Dissipation ....Internally Limited[3]
Lead Temperature (soldering, 3sec.)........................ 260°C
Storage Temperature (T_s) ....–65°C to +150°C
ESD Sensitive[4]

Operating Ratings[2]

Supply Voltage (V_{IN})..................................... +2.3V to +5.5V
Enable Input Voltage (V_{EN1}, V_{EN2}) .... 0V to V_{IN}
POR Voltage (V_{POR1}, V_{POR2}) .... 0V to +5.5V
Junction Temperature (T_J) ....–40°C to +125°C
Junction Thermal Resistance
    2.5mm x 2.5mm Thin MLF-10 (θ_{JA}) ....75°C/W

Electrical Characteristics[5]

V_{IN} = V_{EN1} = V_{EN2} = V_{OUT} + 1.0V, higher of the two regulator outputs; I_{OUT1} = I_{OUT2} = 100µA; C_{OUT1} = C_{OUT2} = 1µF;
T_J = 25°C, **bold** values indicate –40°C $\leq T_J \leq$ +125°C; unless noted.

Parameter	Condition	Min	Typ	Max	Units
Output Voltage Accuracy	Variation from nominal V_{OUT}	–1.0		+1.0	%
	Variation from nominal V_{OUT}; –40°C to +125°C	**–2.0**		**+2.0**	%
Line Regulation	V_{IN} = V_{OUT} +1V to 5.5V; I_{OUT} = 100µA		0.02	0.3	%/V
				0.6	%/V
Load Regulation	I_{OUT} = 100µA to 300mA		0.2	0.5	%
Dropout Voltage	I_{OUT} = 50mA		20	**40**	mV
	I_{OUT} = 300mA		120	**240**	mV
Ground Current	V_{EN1} = High; V_{EN2} = Low; I_{OUT} = 100µA to 300mA		25	**50**	µA
	V_{EN1} = Low; V_{EN2} = High; I_{OUT} = 100µA to 300mA		25	**50**	µA
	V_{EN1} = V_{EN2} = High; I_{OUT1}= 300mA, I_{OUT2} = 300mA		40	**75**	µA
Ground Current in Shutdown	V_{EN1} = $V_{EN2} \leq$ 0.2V		0.01	1.0	µA
Ripple Rejection	f = 1kHz; C_{OUT} = 2.2µF		65		dB
	f = 20kHz; C_{OUT} = 2.2µF		45		dB
Current Limit	V_{OUT} = 0V	350	550	800	mA
Output Voltage Noise	C_{OUT}=1µF; 10Hz to 100kHz		50		μV_{RMS}
Enable Inputs (EN1/EN2)					
Enable Input Voltage	Logic Low			**0.2**	V
	Logic High	**1.2**			V
Enable Input Current	$V_{IL} \leq$ 0.2V		0.01	**1.0**	µA
	$V_{IH} \geq$ 1.2V		0.01	**1.0**	µA
Turn-on Time					
Turn-on Time (LDO1 and 2)	C_{OUT} = 1µF (Enable of First LDO)		140	**500**	µs
	C_{OUT} = 1µF (Enable of Second LDO after First Enabled)		110	**500**	µs
POR1/POR2 Output					
V_{TH}	Low Threshold, % of V_{OUT} (POR ON)	88			%
	High Threshold, % of V_{OUT} (POR OFF)			98	%
V_{OL}	POR Output Logic Low Voltage; I_L = 250µA		0.02	**0.1**	V
I_{POR}	POR Leakage Current, POR OFF	**–1.0**	0.01	**+1.0**	µA

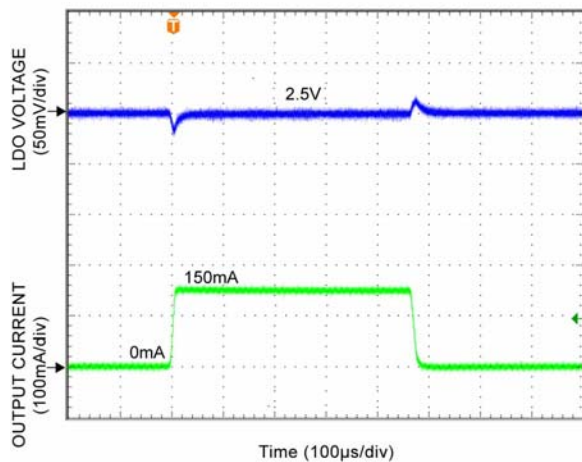| Parameter	Condition	Min	Typ	Max	Units
CSET1/CSET2 INPUT					
CSET Pin Current Source	V_{CSET} = 0V	**0.8**	1.4	**2**	µA
CSET Pin Threshold Voltage	POR = High	**1.21**	1.25	**1.29**	V

Notes:

1. Exceeding the absolute maximum rating may damage the device.

2. The device is not guaranteed to function outside its operating rating.

3. The maximum allowable power dissipation of any T_A (ambient temperature) is $P_{D(max)} = (T_{J(max)} - T_A) / \theta_{JA}$. Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator will go into thermal shutdown.

4. Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5kΩ in series with 100pF.

5. Specification for packaged product only.
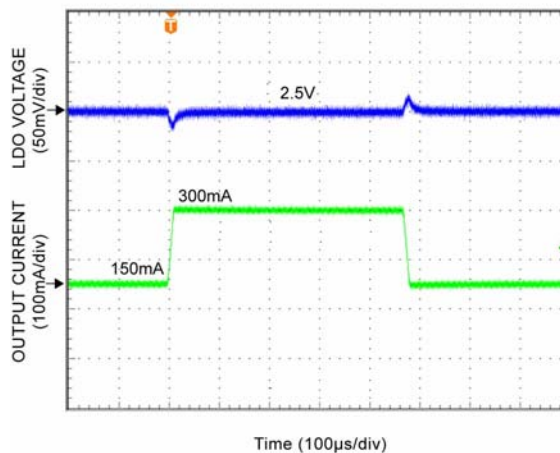
Typical Characteristics

PSRR

PSRR

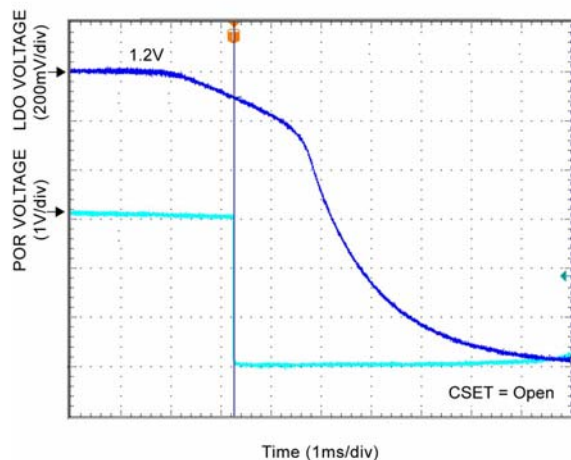
Dropout Voltage vs. Load Current

Dropout Voltage vs. Temperature

Ground Current vs. Supply Voltage

Ground Current vs. Load Current

Ground Current vs. Temperature

Output Voltage vs. Load Current

Output Voltage vs. Temperature

Current Limit vs. Supply Voltage

POR Delay vs. CSET

Output Noise Spectral Density
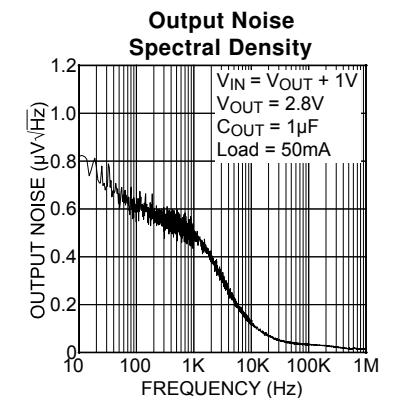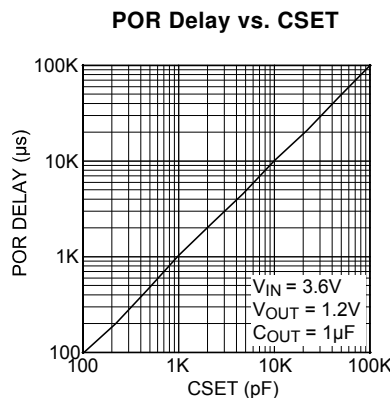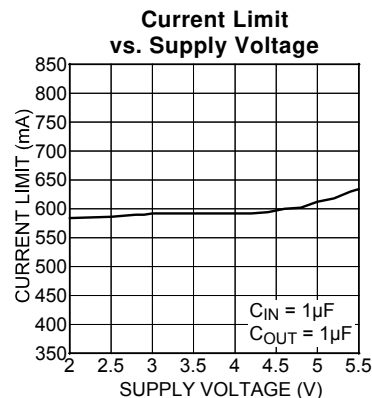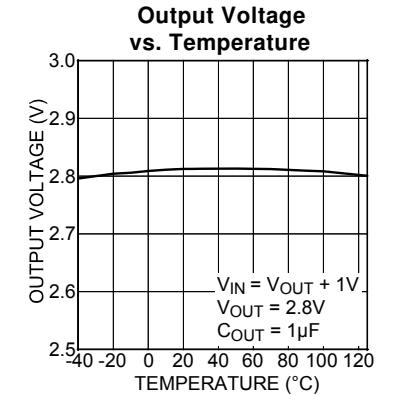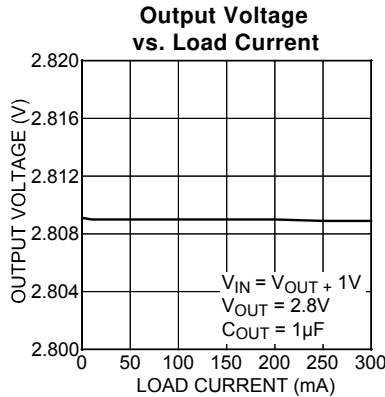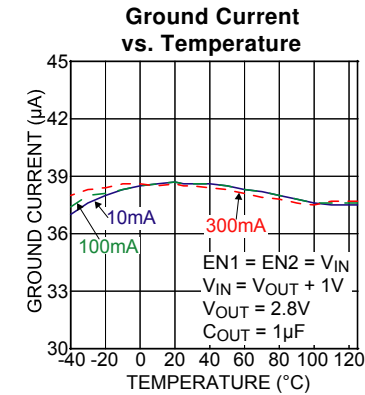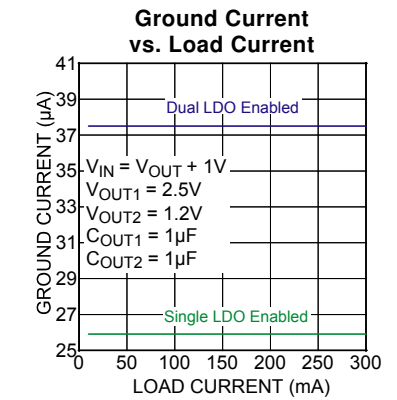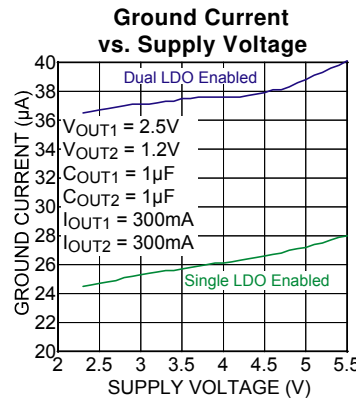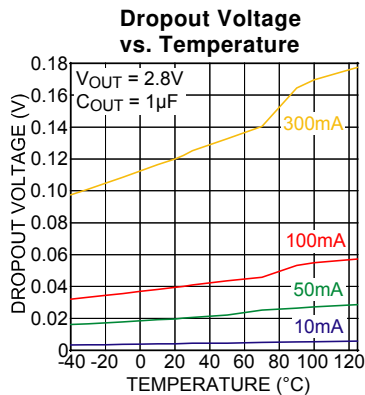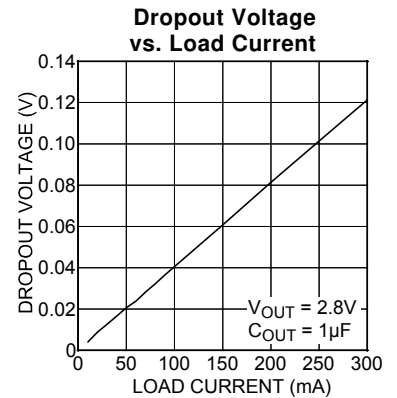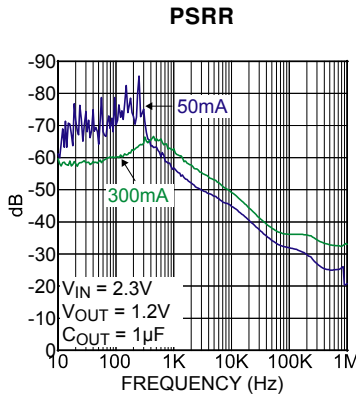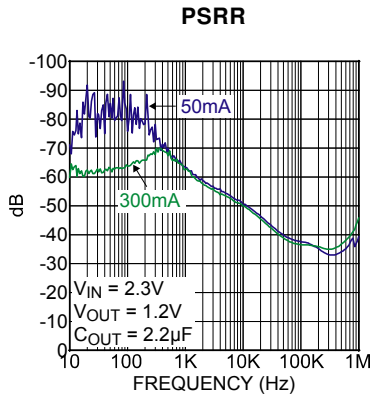
Functional Characteristics

Load Transient (0mA-150mA)

LDO VOLTAGE (50mV/div)

2.5V

OUTPUT CURRENT (100mA/div)

150mA

0mA

Time (100μs/div)

Load Transient (150mA-300mA)

LDO VOLTAGE (50mV/div)

2.5V

OUTPUT CURRENT (100mA/div)

300mA

150mA

Time (100μs/div)

POR Signal (High-Low)

LDO VOLTAGE (200mV/div)

1.2V

POR VOLTAGE (1V/div)

CSET = Open

Time (1ms/div)

POR Signal (Low-High)

LDO VOLTAGE (200mV/div)

1.2V

POR VOLTAGE (1V/div)

CSET = Open

Time (10μs/div)

Enable Turn-On

ENABLE (2V/div)

LDO1/LDO2 VOLTAGE (2V/div)

$V_{IN} = V_{EN1} = V_{EN2} = V_{OUT1} + 1V$
$V_{OUT1} = V_{OUT2} = 3.0V$
$C_{IN} = 1\mu F$
$C_{OUT1} = C_{OUT2} = 1\mu F$

Time (40μs/div)
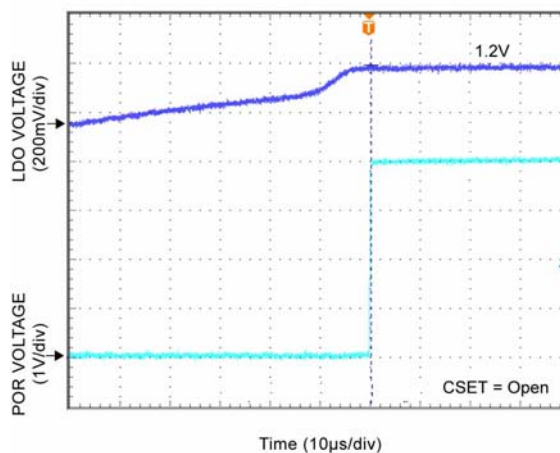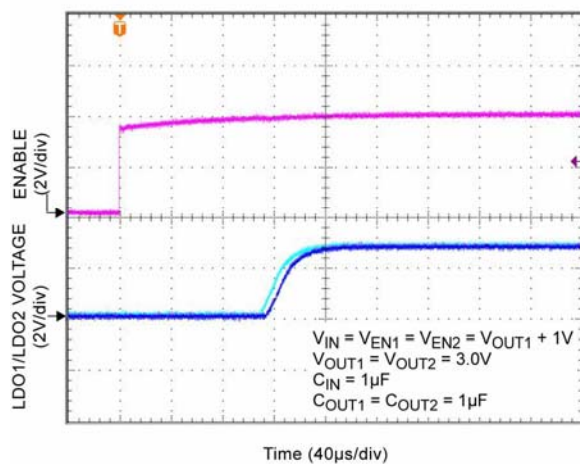
Functional Diagram
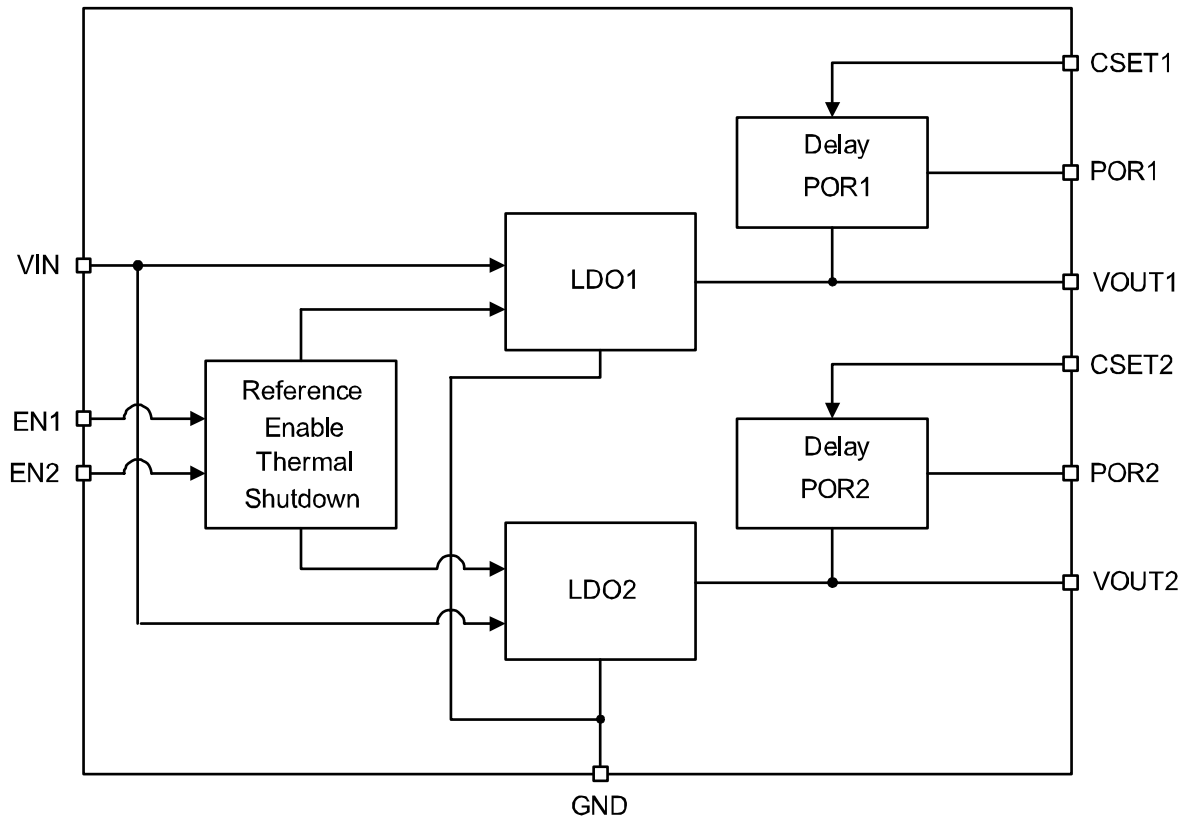
MIC5333 Block Diagram

Application Information

MIC5333 is a dual 300mA LDO, with an integrated Power On Reset (POR) for each of the regulators. The MIC5333 regulator is fully protected from damage due to fault conditions, offering linear current limiting and thermal shutdown.

Input Capacitor

The MIC5333 is a high-performance, high bandwidth device. Therefore, it requires a well-bypassed input supply for optimal performance. A 1µF capacitor is required from the input to ground to provide stability. Low-ESR ceramic capacitors provide optimal performance at a minimum of space. Additional high-frequency capacitors, such as small-valued NPO dielectric-type capacitors, help filter out high-frequency noise and are good practice in any RF-based circuit. X5R or X7R dielectrics are recommended for the input capacitor. Y5V dielectrics lose most of their capacitance over temperature and are therefore, not recommended.

Output Capacitor

The MIC5333 requires an output capacitor of 1µF or greater to maintain stability. The design is optimized for use with low-ESR ceramic chip capacitors. High ESR capacitors may cause high frequency oscillation. The output capacitor can be increased, but performance has been optimized for a 1µF ceramic output capacitor and does not improve significantly with larger capacitance.

X7R/X5R dielectric-type ceramic capacitors are recommended because of their temperature performance. X7R-type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change value by as much as 50% and 60%, respectively, over their operating temperature ranges. To use a ceramic chip capacitor with Y5V dielectric, the value must be much higher than an X7R ceramic capacitor to ensure the same minimum capacitance over the equivalent operating temperature range.

No-Load Stability

Unlike many other voltage regulators, the MIC5333 will remain stable and in regulation with no load. This is especially important in CMOS RAM keep-alive applications.

Enable/Shutdown

The MIC5333 comes with dual active-high enable pins that allow each regulator to be disabled independently. Forcing the enable pin low disables the regulator and sends it into a "zero" off-mode-current state. In this state, current consumed by the regulator goes nearly to zero. Forcing the enable pin high enables the output voltage.

The active-high enable pin uses CMOS technology and the enable pin cannot be left floating; a floating enable pin may cause an indeterminate state on the output.

Power On Reset

Each of the regulator outputs has a Power On Reset status pin (POR1/POR2). This pin is an open drain output. When an LDO is enabled an active low POR indicates an under voltage condition on V_{OUT}.

Each POR status signal can be programmed for a delay of 1sec/µF by placing a capacitor from its associated CSET pin to ground. Where the CSET1 pin sets the delay for the POR1 output and the CSET2 pin sets the delay for the POR2 output. Zero delay is added by leaving the CSET1/2 pin open circuit.

Thermal Considerations

The MIC5333 is designed to provide 300mA of continuous current for both outputs in a very small package. Maximum ambient operating temperature can be calculated based on the output current and the voltage drop across the part. For example if the input voltage is 3.6V, the output voltage is 3.0V for V_{OUT1}, 2.8V for V_{OUT2} and the output current = 300mA. The actual power dissipation of the regulator circuit can be determined using the equation:

$P_D = (V_{IN} - V_{OUT1})\,I_{OUT1} + (V_{IN} - V_{OUT2})\,I_{OUT2} + V_{IN}\,I_{GND}$

Because this device is CMOS and the ground current is typically <100µA over the load range, the power dissipation contributed by the ground current is <1% and can be ignored for this calculation.

$P_D = (3.6V - 3.0V) \times 300mA + (3.6V - 2.8) \times 300mA$

$P_D = 0.42W$

To determine the maximum ambient operating temperature of the package, use the junction-to-ambient thermal resistance of the device and the following basic equation:

$$P_{D(MAX)} = \left(\frac{T_{J(MAX)} - T_A}{\theta_{JA}} \right)$$

$T_{J(max)}$ = 125°C, and the maximum junction temperature of the die, θ_{JA}, thermal resistance = 75°C/W.

Substituting P_D for $P_{D(max)}$ and solving for the ambient operating temperature will give the maximum operating conditions for the regulator circuit. The junction-to-ambient thermal resistance for the minimum footprint is 75°C/W.

The maximum power dissipation must not be exceeded for proper operation.

For example, when operating the MIC5333-PMYMT at an input voltage of 3.6V and 300mA loads at each output with a minimum footprint layout, the maximum ambient operating temperature T_A can be determined as follows:

$0.42W = (125°C – T_A)/(75°C/W)$

$T_A = 93.5°C$

Therefore, a 3.0V/2.8V application with 300mA at each output current can accept an ambient operating temperature of 93.5°C in a 2.5mm x 2.5mm MLF® package. For a full discussion of heat sinking and thermal effects on voltage regulators, refer to the "Regulator Thermals" section of *Micrel's Designing with Low-Dropout Voltage Regulators* handbook. This information can be found on Micrel's website at:

http://www.micrel.com/_PDF/other/LDOBk_ds.pdf

MIC5333 Typical Application Circuit
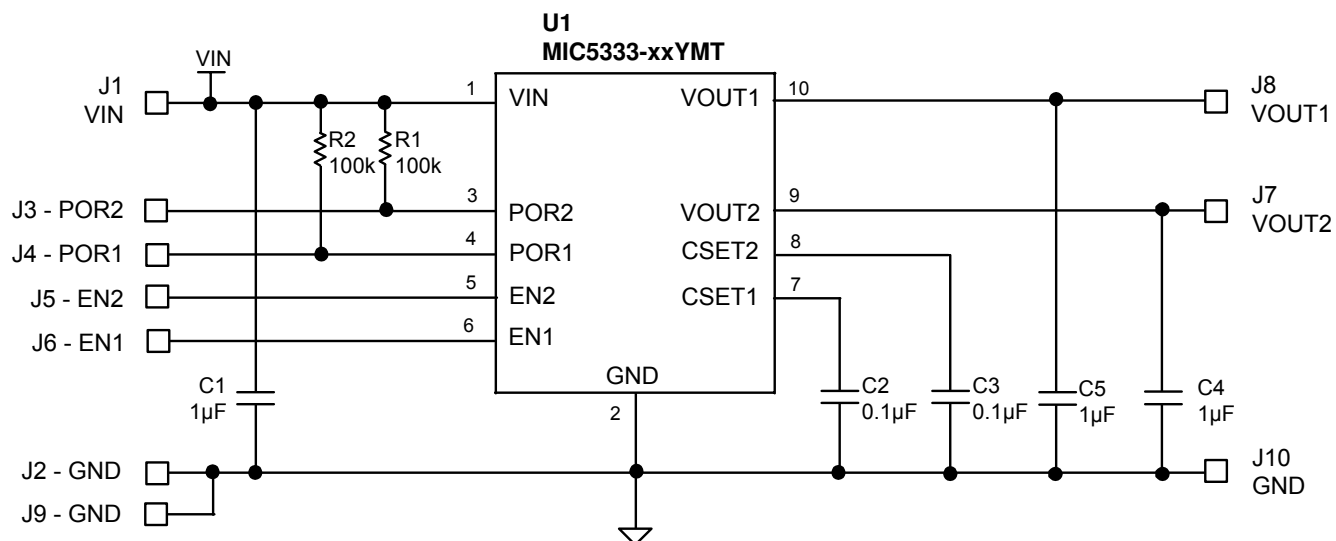
Bill of Materials

Item	Part Number	Manufacturer	Description	Qty
C1, C4, C5	C1608X5R0J105K	TDK[1]	Capacitor, 1µF Ceramic, 6.3V, X5R, Size 0603	3
C2, C3	VJ0603Y104KXXAT	Vishay[2]	Capacitor, 0.1µF Ceramic, 10V, X7R, Size 0603	2
R1, R2	CRCW06031003FRT1	Vishay[2]	Resistor, 100kΩ, 1%, 1/16W, Size 0603	2
U1	**MIC5333-XXYMT**	**Micrel**[3]	**UCAP LDO, Dual 300mA with dual POR, 2.5mm x 2.5mm Thin MLF®**	**1**

Notes:

1. TDK: www.tdk.com

2. Vishay: www.vishay.com

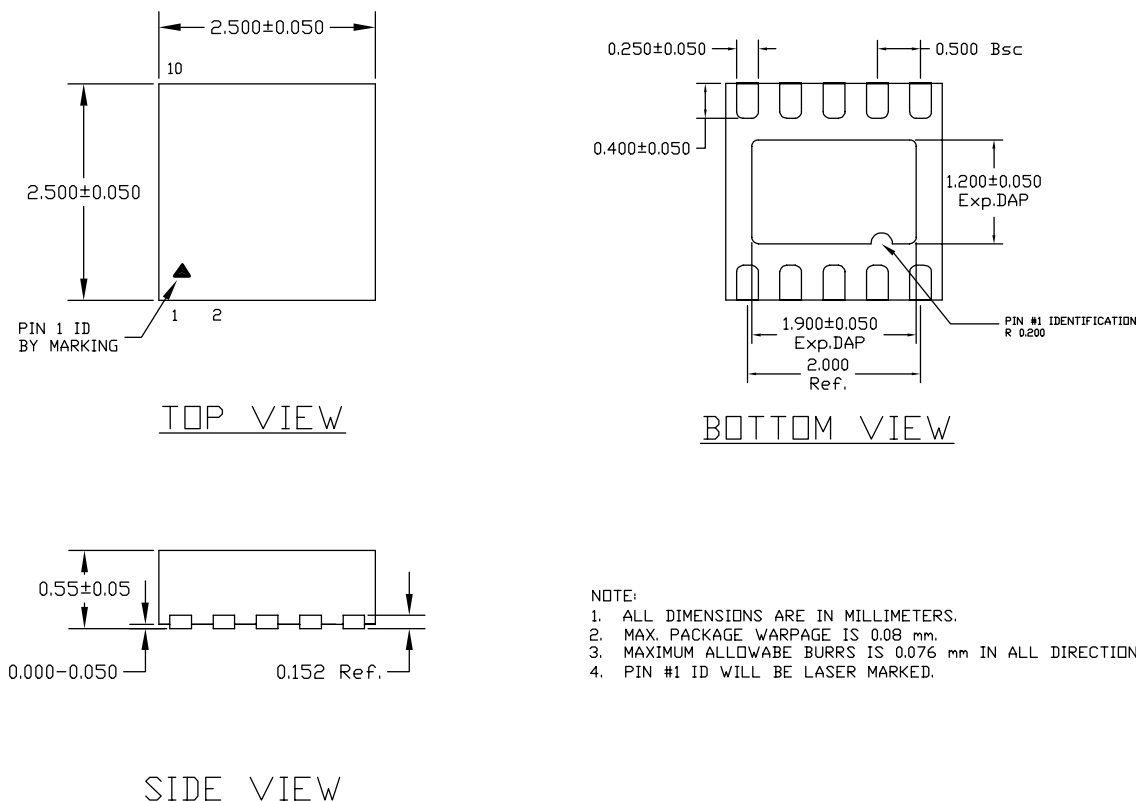3. **Micrel, Inc.: www.micrel.com**

PCB Layout Recommendations
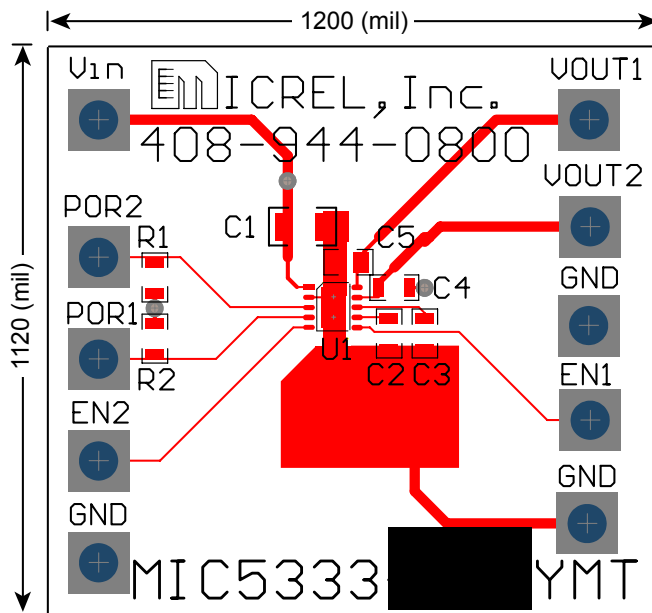
Top Layer
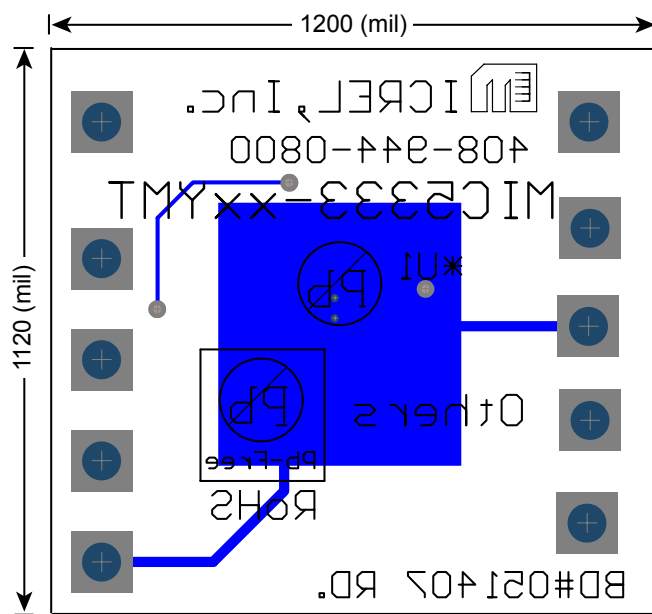
Bottom Layer

Package Information

2.500±0.050

2.500±0.050

PIN 1 ID
BY MARKING

1   2

10

TOP VIEW

0.250±0.050   0.500 Bsc

0.400±0.050

1.200±0.050
Exp.DAP

1.900±0.050
Exp.DAP
2.000
Ref.

PIN #1 IDENTIFICATION
R 0.200

BOTTOM VIEW

0.55±0.05

0.000-0.050   0.152 Ref.

SIDE VIEW

NOTE:
1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. MAX. PACKAGE WARPAGE IS 0.08 mm.
3. MAXIMUM ALLOWABE BURRS IS 0.076 mm IN ALL DIRECTIONS.
4. PIN #1 ID WILL BE LASER MARKED.

10-Pin 2.5mm x 2.5mm Thin MLF® (MT)